

## (12) INTERNATIONAL APPLICATION PUBLISHED UNDER THE PATENT COOPERATION TREATY (PCT)

(19) World Intellectual Property Organization  
International Bureau



PCT



(43) International Publication Date  
4 November 2004 (04.11.2004)

(10) International Publication Number  
WO 2004/094319 A1

(51) International Patent Classification<sup>7</sup>:

C02F 1/48

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(21) International Application Number:

PCT/NO2004/000116

(81) Designated States (unless otherwise indicated, for every kind of national protection available): AE, AG, AL, AM, AT, AU, AZ, BA, BB, BG, BR, BW, BY, BZ, CA, CH, CN, CO, CR, CU, CZ, DE, DK, DM, DZ, EC, EE, EG, ES, FI, GB, GD, GE, GH, GM, HR, HU, ID, IL, IN, IS, JP, KE, KG, KP, KR, KZ, LC, LK, LR, LS, LT, LU, LV, MA, MD, MG, MK, MN, MW, MX, MZ, NA, NI, NO, NZ, OM, PG, PH, PL, PT, RO, RU, SC, SD, SE, SG, SK, SL, SY, TJ, TM, TN, TR, TT, TZ, UA, UG, US, UZ, VC, VN, YU, ZA, ZM, ZW.

(22) International Filing Date: 23 April 2004 (23.04.2004)

(25) Filing Language:

English

(26) Publication Language:

English

(30) Priority Data:

0309224.4

23 April 2003 (23.04.2003)

GB

(84) Designated States (unless otherwise indicated, for every kind of regional protection available): ARIPO (BW, GH, GM, KE, LS, MW, MZ, SD, SL, SZ, TZ, UG, ZM, ZW), Eurasian (AM, AZ, BY, KG, KZ, MD, RU, TJ, TM), European (AT, BE, BG, CH, CY, CZ, DE, DK, EE, ES, FI, FR, GB, GR, HU, IE, IT, LU, MC, NL, PL, PT, RO, SE, SI, SK,

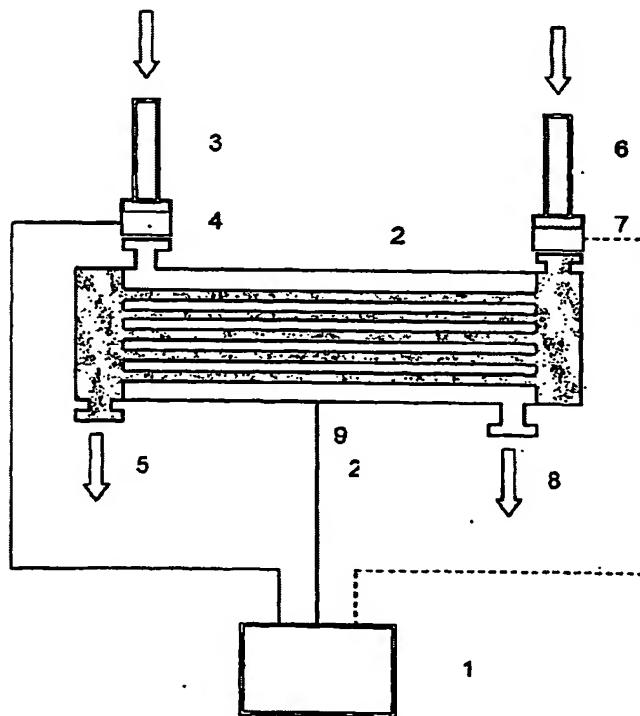
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*[Continued on next page]*

(54) Title: METHOD FOR FLOW IMPROVEMENT AND REDUCTION OF FOULING IN PROCESS EQUIPMENT



**(57) Abstract:** This invention relates to a method and apparatus for improvement of flow rates and reduction of fouling in process equipment such as for instance heat exchangers (2) where fluids are flowing in single or multiphase. This is obtained by imposing a DC-potential at the walls of the process equipment that exactly opposes the naturally occurring potential due to interaction between the walls of the process equipment and the fluid flowing inside. An improved flow rate will cause that the heat exchanger (2) becomes more efficient, i.e. a lower deposition rate and a higher removal rate of inorganic agents. The fluid may be a pure fluid, colloidal fluid or contain inclusions in the form of particles.